

- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input and Output Levels
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages

## description

The SN74CBT16211 provides 24 bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

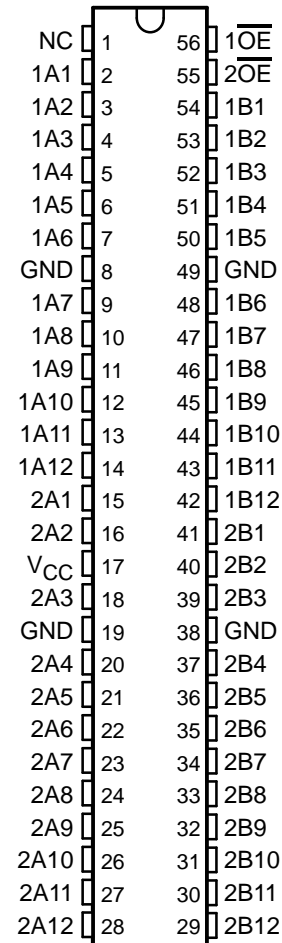
The device operates as a 12-bit or 24-bit bus switch. When  $\overline{1OE}$  is low, 1A is connected to 1B. When  $\overline{2OE}$  is low, 2A is connected to 2B.

The SN74CBT16211 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

FUNCTION TABLE

INPUTS		INPUTS/OUTPUTS	
$\overline{1OE}$	$\overline{2OE}$	1A, 1B	2A, 2B
L	L	1A = 1B	2A = 2B
L	H	1A = 1B	Z
H	L	Z	2A = 2B
H	H	Z	Z

DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



NC – No internal connection



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**TEXAS  
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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT	
$V_{IK}$		$V_{CC} = 4.5\text{ V}$ ,	$I_I = -18\text{ mA}$			-1.2	V	
$I_I$		$V_{CC} = 0\text{ V}$ ,	$V_I = 5.5\text{ V}$			10	$\mu\text{A}$	
		$V_{CC} = 5.5\text{ V}$ ,	$V_I = 5.5\text{ V or GND}$			$\pm 1$		
$I_{CC}$		$V_{CC} = 5.5\text{ V}$ ,	$I_O = 0$ ,			3	$\mu\text{A}$	
$\Delta I_{CC}^\ddagger$	Control pins	$V_{CC} = 5.5\text{ V}$ ,	One input at 3.4 V,	Other inputs at $V_{CC}$ or GND		2.5	mA	
$C_i$	Control pins	$V_I = 3\text{ V or 0}$				4.5	pF	
$C_{io(OFF)}$		$V_O = 3\text{ V or 0}$ ,	$\overline{OE} = V_{CC}$			5.5	pF	
$r_{on}^\S$		$V_{CC} = 4\text{ V}$ ,	$V_I = 2.4\text{ V}$ ,	$I_I = 15\text{ mA}$		14	20	$\Omega$
		$V_{CC} = 4.5\text{ V}$	$V_I = 0$	$I_I = 64\text{ mA}$		5	7	
				$I_I = 30\text{ mA}$		5	7	
			$V_I = 2.4\text{ V}$ ,	$I_I = 15\text{ mA}$		8	12	

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

§ Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

**switching characteristics over recommended operating free-air temperature range,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 1)**

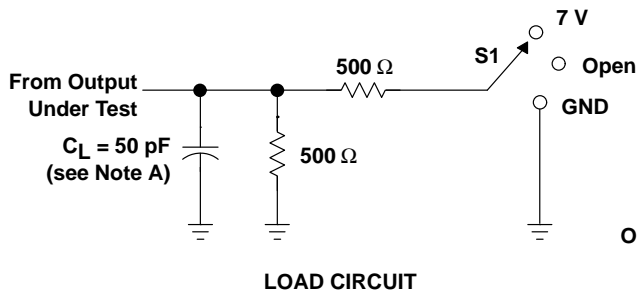
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5\text{ V} \pm 0.5\text{ V}$		$V_{CC} = 4\text{ V}$		UNIT
			MIN	MAX	MIN	MAX	
$t_{pd}^\parallel$	A or B	B or A	0.25		0.25		ns
$t_{en}$	$\overline{OE}$	A or B	3.9	9.3	10.1		ns
$t_{dis}$	$\overline{OE}$	A or B	3.3	8.5	7.1		ns

¶ This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

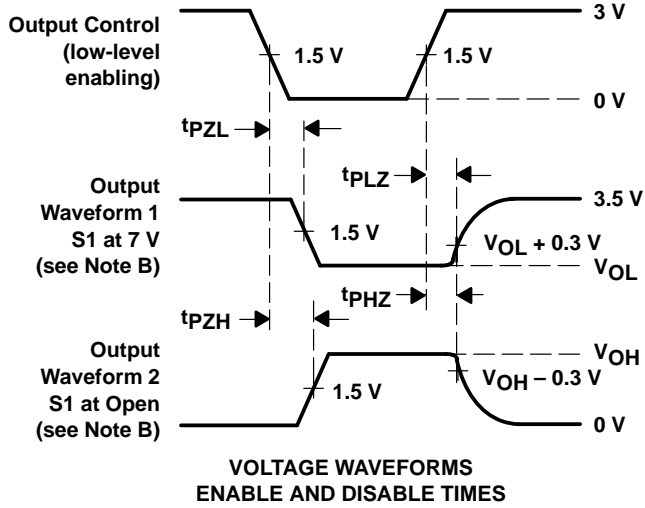
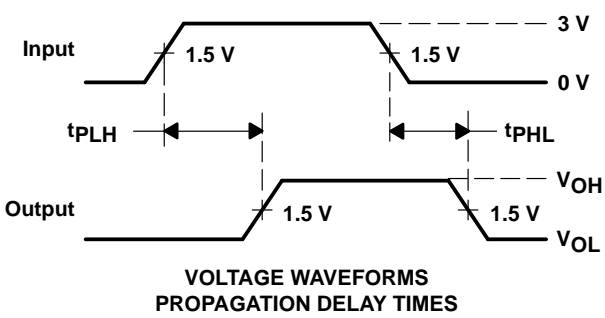
# SN74CBT16211 24-BIT BUS SWITCH

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## PARAMETER MEASUREMENT INFORMATION



TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

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